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Description: Second State	Part Number: 0473080001 Status: Active			
Description: 2.54mm (1007) Pitch SIM Card Holder, Guide and Holder Siyle, 6 Circuits, SMT, with Solider Tabs, Housing Height 2.00mm (0797), with 1 Securing Nail, Lead Free Image: Control of the security of the security Nail Security Nait Security Nail Security Nail Security Nail Security Na	ACTIVE			
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Material Info

Reference - Drawing Numbers

Packaging Specification Product Specification Sales Drawing

PK-47308-001 PS-47308-001 SD-47308-001

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